

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1713	photovoltaic and substrate and silicon and conductivity and surface and (back or backside)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 13:35
S2	763	S1 and ((p-n or pn) with junction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 13:36
S3	25	S2 and (remove with (back or backside))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 16:35
S4	2	("4251285").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 14:30
S5	215	S2 and ITO	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 15:02
S6	126	S5 and photovoltaic.ab.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 16:35
S7	87	S6 and photovoltaic.ti.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 15:03
S8	30	S7 and textur\$4	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 15:03
S9	6	("4253882" "4644091" "4767336" "4956685" "5704992" "6207890").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/02 15:09
S10	10	("4644091").URPN.	USPAT	OR	ON	2005/10/02 15:44
S11	15	("4251285").URPN.	USPAT	OR	ON	2005/10/02 16:21
S12	116	S2 and ((etch\$4 or remove) with (back or backside)) and (silicon with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 16:53

S13	20	S12 and photovoltaic.ab.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:00
S14	112	S2 and ((etch\$4) with (back or backside)) and (silicon with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 16:53
S15	3	S14 and ((etch\$4) with (back or backside)).ab. and (silicon with substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 16:53
S16	18	S14 and photovoltaic.ab.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:37
S17	1	S14 and (texturing with substrate)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:39
S18	11	S2 and (texturing with substrate)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:45
S19	0	S18 and (planariz\$3 with back with substrate)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:40
S20	0	S18 and (planariz\$3 with back)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:40
S21	0	S18 and (planariz\$3 with back)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:40
S22	3	S18 and ((smooth or flat) with back)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:40
S23	21	S2 and ((textur\$3 or groove) with substrate) and ((planar\$3 or flat\$4 or smooth) with (back or backside))	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 17:46
S24	17	("4135950").URPN.	USPAT	OR	ON	2005/10/02 18:28
S25	624	136/246.ccls.	USPAT	OR	ON	2005/10/02 18:46
S26	712	257/431.ccls.	USPAT	OR	ON	2005/10/02 19:21

S27	8	(US-6380479-\$ or US-6207890-\$ or US-6180432-\$ or US-5304500-\$ or US-4251285-\$ or US-6072117-\$ or US-5704992-\$ or US-6541695-\$).did.	USPAT	OR	ON	2005/10/02 18:53
S28	3	S27 and (back adj surface adj field)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/02 18:53
S29	507	438/48.ccls.	USPAT	OR	ON	2005/10/02 19:21